IN THE CAUTED STATES PATENT AND TRADEMARK OFFICE

Applicants:

T. IWASAKI, et al.

Serial No.:

09/255,856

Filed:

February 23, 1999

Title:

SEMICONDUCTOR DEVICE WITH LAYERED

INTERCONNECT STRUCTURE

Group/AU:

2813

Examiner:

Stephen W. Smoot

Confirmation No.:

9089

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97 AND 1.98

Mail Stop: RCE

Commissioner for Patents P.O. Box 1450

Alexandria, Virginia 22313-1450

June 23, 2005

SIR:

Pursuant to Applicants' duty of disclosure, enclosed please find copies of documents to be considered by the Examiner during further examination of the above-identified application. Also enclosed is a Form PTO/SB/08A and B, listing the enclosed documents.

This Information Disclosure Statement is being filed concurrently with the filing of a Request for Continued Examination (RCE) Transmittal in the above-identified application. Accordingly, requirements of 37 CFR 1.97(b) are satisfied.

While the documents LISTED on the enclosed Form are not in English, English-language abstracts for each of the respective documents are enclosed therewith. Accordingly, it is respectfully submitted that requirements of 37 CFR 1.98(a)(3) are satisfied.

Docket No. 501.36931X00 Serial No. 09/255,856 June 23, 2005

In addition, the following comments are made in connection with the enclosed Japanese Patent Document No. 6-236878. As set forth in the English-language patent abstract thereof, No. 6-236878 discloses interposing a barrier layer 43b at a joint between a first copper wiring 41 and a second aluminum alloy wiring 51. Palladium (Pd) is disclosed as this barrier layer. Attention is respectfully directed to paragraph [0026] on page 541 of No. 6-236878. This paragraph discloses that Pd can be replaced by Pt, Ru, or Rh, for layer 51a, between layer 51 (Cu) and 50 (insulator; silicon dioxide). This patent document discloses use of Pt and Ru, etc., as a barrier layer to avoid electromigration.

Attention is also directed to paragraph [0030] of No. 6-236878, on page 542, disclosing that the barrier layer can be formed by techniques such as sputtering, PVD and CVD.

A full English translation of Japanese Patent Document No. 6-236878 is to be submitted in due course. If this full English translation is not in the file of the above-identified application as of the date that the Examiner takes up the above-identified application for further examination, the Examiner is respectfully requested to contact the undersigned, to determine the status of such full English translation. The Examiner is thanked in advance for cooperating with this request.

Consideration of the documents listed on the enclosed Form, upon further examination of the above-identified application, is respectfully requested.

Docket No. 501.36931X00 Serial No. 09/255,856 June 23, 2005

Applicants request any shortage of fees due in connection with the filing of this paper be charged to the Deposit Account of Antonelli, Terry, Stout & Kraus, LLP, Deposit Account No. 01-2135 (case 501.36931X00), and credit any excess fees to such Deposit Account.

Respectfully submitted,

ANTONELLI, TERRY, STOUT & KRAUS, LLP.

William I. Solomon

Registration No. 28,565

WIS/ksh 1300 N. Seventeenth Street Suite 1800 Arlington, Virginia 22209

Tel: 703-312-6600 Fax: 703-312-6666

PTO/SB/08A (08-03)

Approved for use through 07/31/2006. OMB 0651-0031
U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

Unde				uired to respond to a collection of in	formation unless it contains a valid OMB control number.	
	for form 1449A/PTO			Complete if Known		
INFOR	RMATION DISCLOSUR BY APPLICAN		TATEMENT	Application Number	09255,856	
	DI AIT LIOAN	•		Filing Date	02/23/1999	
	June 23, 200	5		First Named Inventor	T. IWASAKI	
				Art Unit	2813	
	(use as many sheets as ne	cessa	ry)	Examiner Name	Stephen W. Smoot	
Sheet	1	of	1	Attorney Docket Number	501.36931X00	

	U.S. PATENT DOCUMENTS							
Examiner Initials'	Cite No. ¹	Document Number Number-Kind Code ² (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear			
		US-						
		US-						
		US-						
		US-						
		US-						
		US-						
		US-						
		US-						
		US-						
		US-						
		US-						

	- FOREIG	<u>ON PATENT DOC</u>	UMENIS		
Cite No.1	Foreign Patent Document Country Code ³ -Number ⁴ -Kind Code ⁵ (if known)	Publication Date	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	т°
	JP 06-236878	08/1994	H. Kondo, et al.		Α
	JP 10-256251	09/1998	N. Awaya, et al.		Α
	JP 05-315336	11/1993	I. Mikagi		Α
	JP 09-069522	03/1997	S. Okamoto		Α
	JP 10-284601	10/1998	M. Omura		Α
	JP 10-022274	01/1998	Y. Ashida		Α
	JP 2001-505367	04/2001		Machine translation only	
		Cite No.¹ Country Code³-Number⁴-Kind Code ⁵(if known) JP 06-236878 JP 10-256251 JP 05-315336 JP 09-069522 JP 10-284601 JP 10-022274	Cite No. 1 Country Code 3-Number 4-Kind Code 5 (if known) Publication Date MM-DD-YYYY JP 06-236878 08/1994 JP 10-256251 09/1998 JP 05-315336 11/1993 JP 09-069522 03/1997 JP 10-284601 10/1998 JP 10-022274 01/1998	Cite No.¹ Country Code³-Number⁴-Kind Code ⁵(if known) Publication Date MM-DD-YYYY Name of Patentee or Applicant of Cited Document JP 06-236878 08/1994 H. Kondo, et al. JP 10-256251 09/1998 N. Awaya, et al. JP 05-315336 11/1993 I. Mikagi JP 09-069522 03/1997 S. Okamoto JP 10-284601 10/1998 M. Omura JP 10-022274 01/1998 Y. Ashida	Cite No. 1 Country Code 3-Number 4-Kind Code 5 (if known) Publication Date MM-DD-YYYY Name of Patentee or Applicant of Cited Document Where Relevant Passages or Relevant Figures Appear JP 06-236878 08/1994 H. Kondo, et al. JP 10-256251 09/1998 N. Awaya, et al. JP 05-315336 11/1993 I. Mikagi JP 09-069522 03/1997 S. Okamoto JP 10-284601 10/1998 M. Omura JP 10-022274 01/1998 Y. Ashida JP 2001-505367 04/2001 Machine translation

Examiner	Date
Signature	Considered

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. 1 Applicant's unique citation designation number (optional). 2 See Kinds Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. 3 Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). 4 For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. 5 Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. 6 Applicant is to place a check mark here if English language Translation is attached.

This collection of information is required by 37 CFR 1.97 and 1.98. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 2 hours to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.